Index to ELECTRI•ONICS 1983 Feature Articles

Coil and Motor Manufacturing Tips	Page	Issue
Progress in Automating Coil Winding and Insertion for Three Phase Induction Motor Stators	43	Jan.
Comparing Amorphous Metal Transformer Core Structures	88	Feb.
Split Coil Forms for Rotary Transformers	52	Mar.
Configuration Guidelines in the Optimal Use of Ferrite Cores	51	April
Flexible Electrical Insulation for Bondable Wire Systems	59	May
Ceramic-Like, High Temperature Insulation for Motors, Transformers ... 1½ Years Later	81	June
Performance of Asbestos Insulation Systems in Dry Type Transformers	67	July
Motor Insulation Systems for High-Moisture Applications	67	Aug.
Testing for Magnet Wire Windability	71	Aug.
Monitoring Coil Winding Equipment Usage for Production Scheduling	67	Sept.
Preview of Electrical/Electronics Insulation Conference — Coil Winding '83	70	Sept.
Improving Efficiency of Induction Motors Through Design	139	Oct.
Designing Carbon Brushes to Enhance Motor Performance	51	Nov.
Improved Fault Identification with Surge Testing of Motor Windings	55	Nov.

ELECTRI•ONICS Forum	Page	Issue
"Do any military specifications need modification?"	6	Jan.
"What test procedures are the most difficult?"	6	Feb.
"What areas of your operation had the greatest increase in productivity?"	6	Mar.
"What coil, motor, and transformer manufacturing improvements are most needed?"	6	April
"What lies ahead for hybrid circuits?"	12	May
"What areas of circuit assembly technology need improvement?"	6	June
"Where is circuit cleaning technology heading?"	13	July
"What are the principal effects of CAD/CAM on PC development and production?"	12	Aug.
"How are developments in PC processing chemicals affecting the industry?"	12	Sept.
"What connector advances are required to meet increasing packaging density requirements?"	12	Oct.
"What advances in test technology are changing test planning?"	6	Nov.
"What significant advances have occurred in electric motors technology?"	6	Dec.

Connection and Termination Corner	Page	Issue
Beyond Particle Counters	36	Jan.
Connector Alternative to Plated Fingers on a PWB	70	Feb.
Test Connector System Developed for Efficient Use	37	Mar.
Metal Fabrication Technology Bypassing Traditional Constraints	53	April
Wire Marking: A Changing Technology	55	May
Surface Mounting of Components With Elastomeric Connectors	54	June
"Universal" Mass Termination Plug Simplifies Connection Problems	68	June
Laminated Strips: An Effective Method for Insulating Connectors	71	July
Simplifying Microelectronic Assembly With Precision Metal Stampings	59	Aug.
Card-Edge Connector Design for Cost-Effective Backplanes	54	Sept.
Preview of 16th Annual Connectors and Interconnection Technology Symposium	76	Oct.
Special Report: Connections and Terminations Fundamentals	86	Oct.
Two-Piece Connectors on Upswing, One-Piece Card Edge Systems Down	39	Nov.
Wire and Cable Fundamentals	46	Dec.

Electronic Production Abroad	Page	Issue
The Home-Grown Strength of Indonesia's Electronics Industry	29	Jan.
Update on the Electronic Industry in Austria	68	Feb.
Update on the Electronic Industry in Switzerland	29	Mar.
Update on the Electronic Industry in Thailand	46	April
Update on the Electronic Industry in the Arabian Peninsula	43	May
Update on the Electronic Industry in Finland	58	July
Update on the Electronic Industry in Japan	55	Aug.
Update on the Electronic Industry in Portugal	61	Sept.
Update on the Electronic Industry in the Philippines	134	Oct.

From the Editor	Page	Issue
Introducing ELECTRI•ONICS	4	Jan.
Opinions and Rambling Thoughts	4	Feb.
Opinions and Rambling Thoughts	4	Mar.
Opinions and Rambling Thoughts	4	April
Opinions and Rambling Thoughts	6	May
Blue and White Collar Productivity	4	June
Autofac: Labor's Foe or Friend?	6	July
Opinions and Rambling Thoughts	6	Aug.
Show and Tell	6	Sept.
The Circuit Connection	4	Oct.
The Many Faces of Yield Improvement	4	Nov.
Looking Forward to '84	4	Dec.

Hybrid Circuit Workshop	Page	Issue
Alternate Substrates to Alumina for Microelectronics — Part 2	19	Jan.
Circuit Challenges and Opportunities for the 1980's	13	Feb.
New Technologies in Electronic Materials and Processes for the '80's	13	Mar.

Certification Requirements for Hybrid Microcircuit Facilities and Lines	25	April
Advantages of Electroless Nickel Plating of Hybrid Circuits	20	May
The Natural Integration of SAW and Hybrid Technologies	46	June
Choosing an Automatic Component Distribution System for Hybrid Circuit Manufacturing	43	July
Nitrogen-Filled Storage Cabinets Avoid Oxidation of Hybrid Components	29	Aug.
Electroplating Important In Manufacturing Cofired Multilayer Ceramic Modules and Packages	25	Sept.
Thick Film Processing and Higher Yields: Part 4 — Wire Bonding	43	Sept.
Automating Thick Film Processes Improves Hybrid Circuits	27	Oct.
Preview of ISHM '83	127	Oct.
CAD/CAM Improves Design and Manufacturing Productivity for Hybrids, Membrane Switches	27	Nov.
Using Ultrasonics for Cleaning Hybrid Circuits	30	Dec.

Printed Circuit Techniques	**Page**	**Issue**
Color Photography: An Aid to Decrease PCB Rework	15	Jan.
The Use of Machine Vision for PCB Inspection	23	Jan.
Special Report: Printed Circuit Fundamentals	25	Feb.
A Systematic Approach to Multilayer Dimensional Stability	19	Mar.
A Screenless PCB Imaging System	23	Mar.
Make Sure Static Control Products Control Static	19	April
Reliable Fabrication of PWB's With Dry Film Photoresists	33	April
Can PWB's Meet the Surface Mount Challenge? — Part 1	25	May
$54,000/Year Savings, 400% Quality Improvement in Complex PCB Operations	29	June
Can PWB's Meet the Surface Mount Challenge? — Part 2	35	June
PC Board Laminators Cut Costs by $-Thousands Per Year With New Presspad	40	June
Polymer Thick Film: Updating Today's Technology	27	July
Solvents vs. Aqueous: The Debate Goes On	37	July
Industrial Robot Speeds PWB Fabrication	53	July
PCB's Use Screen Printed Conducting Paths	27	Aug.
A Systems Approach to ESD Safe Floors, Work Surfaces, Material Handling	37	Aug.
CAD/CAM Impact on the Printed Wiring Industry	45	Aug.
New Circuit Materials Hold Shape After Bending, Process Like Rigid Boards	29	Sept.
Preview of Circuit Expo '83	49	Oct.
Polystyrene Encapsulant Allows Circuit Rework	73	Oct.
Flexible Printed Circuit Covercoat Lamination Using Thick Polyimide Films	79	Oct.
Automatic Inspection for Printed Wiring — Part 1	21	Nov.
Treating Copper With Brown Oxide for Improving Multilayer Board Adhesion	29	Nov.
Automatic Inspection for Printed Wiring — Part 2	27	Dec.

Production Soldering Clinic	**Page**	**Issue**
Soldering of Leadless Components	13	Jan.
Hot Tinning of Printed Wiring Boards	19	Feb.
Causes and Effects of Solder Contamination — Part 1	44	Mar.
Causes and Effects of Solder Contamination — Part 2	41	April
Causes and Effects of Solder Contamination — Part 3	51	May
How to Wave Solder Discrete Chip Components	21	June
Systemizing Identification of Equipment Requirements/Selection for Solder/Deflux System	49	July
High Temperature Thermoplastic Polyester for Vapor Phase Soldering	51	Aug.
Solder Paste Compositions and Application Techniques for PWB's — Part 1	37	Sept.
Solder Paste Compositions and Application Techniques for PWB's — Part 2	43	Oct.
Minimizing Defects in the Mass Soldering of Printed Wiring Assemblies	35	Nov.
Hot Gas Desoldering Cuts Hybrid and PCB Repair Costs	35	Dec.

Testing Spotlight		
Analysis of Residual Gas In Electronic Devices	33	Jan.
Transformer Testing for Acceptability, Classification, and Expected Life	83	Feb.
Insulation Testing by Surge Comparison for Quality Control	57	Mar.
How to Select Probes and Fixtures to Meet Your Testing Needs	28	April
PWB Quality Evaluation Through Microsectioning	28	May
Surge Testing: A Quality Control Procedure for Electrical Windings	77	June
Metal Film Analysis With Fluorescent X-rays	61	July
Special Report: Testing Fundamentals	76	Aug.
Preview of 1983 International Test Conference	60	Sept.
Analysis of Computer Manufacturer's PC Quality Assurance Program	37	Oct.
Networking Strategies to Integrate CAD/CAM/CAT	19	Nov.
Improving Device Evaluation by Highly Accelerated Temperature/Humidity Testing	41	Dec.

Other Feature Articles	**Page**	**Issue**
Preview: Southcon/83	49	Jan.
Preview of SEMICON/Europa '83	79	Feb.
Tandem Pumping System Handles Hazardous Chemicals in Electronic Plant	26	Mar.
Is Your Company Suffering From a Backache?	41	Mar.
The Advantages of Rotary Switches	53	Mar.
Special Report: Materials, Metals, Plastics Fundamentals	59	April
How to Choose Deflashing Techniques to Meet Your Needs — Part 1	40	May
Preview of SEMICON/West '83	47	May
Choosing Deflashing Techniques to Meet Your Needs — Part 2	63	June
Preview of SEMICON/East '83	99	Aug.
Preview of Southwest Semiconductor and Electronics Expo	49	Sept.
Preview of SEMICON/Southwest '83	50	Sept.
Preview of Productronica '83	137	Oct.
Preview of 32nd Annual International Wire and Cable Symposium	141	Oct.
Forecast 1984	19	Dec.
Special Report: Wire and Cable Fundamentals	46	Dec.